Claims

- 1. A shaped resistive heater comprising a resistive element and an electrically insulating element, wherein said heater has a fixed, non-planar shape that is conformal to at least a portion of an object to be heated, wherein said heater is not adhered to said object.
- 2. The heater of claim 1, comprising two electrically insulating elements, wherein said resistive element is disposed between said electrically insulating elements.

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- 3. The heater of claim 1, further comprising a power supply that is electrically coupled to said resistive element, wherein the application of current from said power supply results in the production of heat by said resistive element.
- 4. The heater of claim 1, further comprising a thermal barrier element.
 - 5. The heater of claim 4, wherein said thermal barrier element comprises zirconium oxide.
- 6. The heater of claim 1, wherein said electrically insulating element comprises aluminum oxide, silicon dioxide, or mica.
 - 7. The heater of claim 1, wherein said resistive element comprises a Ni-Cr alloy, titanium (Ti), silicon (Si), aluminum (Al), zirconium (Zr), cobalt (Co), nickel (Ni), iron (Fe), FeCrAl, or alloys thereof.
 - 8. The heater of claim 1, wherein said resistive element is formed by thermally spraying, machining, casting, sintering, PVD, or CVD.

- 9. The heater of claim 1, further comprising one or more additional resistive elements.
- 5 10. The heater of claim 1, further comprising one ore more thermal sensors.
 - 11. The heater of claim 10, wherein said thermal sensors comprise an array of thermocouples.

- 12. A method of heating an object, said method comprising the steps of:
- a) providing a shaped resistive heater comprising a resistive element and an electrically insulating element, wherein said heater has a fixed, non-planar shape that is conformal to at least a portion of said object, wherein said heater is not adhered to said object;
 - b) placing said heater into conformal contact with said object; and
 - c) applying current to said resistive element to produce heat.
- 13. The method of claim 12, further comprising the step of (c) replacing said shaped heater with a second shaped heater after one or more applications of current to said resistive element.
 - 14. A mold comprising:
- a) a shell comprising a cavity side and a back side, wherein said cavity side
 defines a mold cavity;
 - b) a resistive heater comprising a resistive element and an electrically insulating element, wherein said heater is shaped to conform to at least a portion of said back side of said shell, and said heater is in conformal contact with said back side of said shell; and

- c) a housing capable of physically supporting said shell and said heater, wherein said heater is disposed between said shell and said housing.
- 15. The mold of claim 14, wherein said resistive heater in step (b) isadhered to at least a portion of said back side of said shell.
 - 16. The mold of claim 14, wherein said resistive heater in step (b) is not adhered to said shell.
- 17. The mold of claim 14, further comprising a thermal barrier element disposed between said heater and said housing.
 - 18. The mold of claim 14, further comprising a cooling jacket.
- 19. The mold of claim 14, wherein said resistive heater is coupled to a power supply, wherein application of current from said power supply results in production of heat by said resistive element.
- 20. The mold of claim 14, wherein an electrically insulating element is disposed between said resistive element and said back side.
 - 21. The mold of claim 14, wherein an electrically insulating element is disposed between said housing and said resistive element.
- 25 22. The mold of claim 14, further comprising one or more additional heaters.
 - 23. The mold of claim 22, wherein said one or more additional heaters are in conformal contact with said back said.

24. The mold of claim 22, wherein at least a portion of said heater of (b) is disposed between at least a portion of said one or more additional heaters and said back side.

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- 25. The mold of claim 14, further comprising one or more thermal sensors.
- 26. The mold of claim 25, wherein said thermal sensors comprise an array of thermocouples.

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- 27. A method of making a molded product, said method comprising the steps of:
 - a) providing a mold comprising:
- i) a shell comprising a cavity side and a back side, wherein said cavity side defines a mold cavity;
 - ii) a resistive heater comprising a resistive element and an electrically insulating element, wherein said heater is shaped to conform to at least a portion of said back side of said shell, and said heater is in conformal contact with said back side of said shell; and

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- iii) a housing capable of physically supporting said shell and said heater, wherein said heater is disposed between said shell and said housing;
 - b) heating said resistive heater by the application of current; and
- c) injecting a material to be molded into said mold, wherein said heated resistive heater regulates the solidification of said material, thereby forming said molded product.
- 28. The method of claim 27, wherein said mold further comprises a cooling jacket.

- 29. The method of claim 27, further comprising step (d) cooling said material in said mold.
- 30. The method of claim 27, wherein said material is a thermoplastic
 material, thermoset material, metal, ceramic, cermet, glass, or combination thereof.
 - 31. A method of making a mold, said method comprising the steps of:
 - a) providing a shell comprising a cavity side and a back side and a housing capable of physically supporting said shell, wherein said cavity side defines a mold cavity; and
 - b) depositing a resistive element on at least a portion of said back side, wherein when said shell is supported by said housing, said resistive element is disposed between said shell and said housing.

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- 32. The method of claim 31, further comprising the steps of:
- c) forming an electrically isolated, resistive heater path in said resistive element; and
- d) connecting said resistive heater path of step (c) to a power supply, thereby fabricating a resistive heater.
 - 33. The method of claim 32, wherein said forming in step (c) is by micromachining, microabrading, laser cutting, chemical etching, or e-beam etching.

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34. The method of claim 31, further comprising the step, prior to step (b), of depositing an electrically insulating element on at least a portion of said back side of said shell.

- 35. The method of claim 31 further comprising the step of:
- c) depositing a thermal barrier element on at least a portion of said resistive element.
- 5 36. The method of claim 31, wherein said shell is produced by electroplating, electroless deposition, molding, spray forming, machining, CVD, or PVD.
 - 37. A method of making a mold, said method comprising the steps of:
 - a) providing a shell comprising a cavity side and a back side and a housing capable of physically supporting said shell, wherein said cavity side defines a mold cavity; and

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- b) forming a resistive heater that has a shape that is conformal to at least a portion of said back side, wherein when said shell and said resistive heater are supported by said housing, said resistive element is disposed between said shell and said housing.
 - 38. The method of 37, wherein said forming in step (b) comprises:
- i) depositing a resistive element on at least a portion of an object replicating
 at least a portion of the shape of said back side; and
 - ii) removing said resistive element from said object.
 - 39. The method of 38, further comprising depositing an electrically insulating element on at least a portion of said object prior to step (i), wherein said removing in step (ii) also removes said electrically insulating element.
 - 40. The method of 38, further comprising depositing an electrically insulating element on at least a portion of said resistive element, before or after step (ii).

- 41. The method of 38, further comprising depositing a thermal barrier element on at least a portion of said resistive element, before or after step (ii).
- 5 42. The method of 38, wherein said depositing comprises thermal spraying.
 - 43. The method of 37, wherein said forming in step (b) comprises:
 - i) providing a second shell having a shape conformal to at least a portion of said back side; and
- ii) depositing a resistive element on said second shell.

- 44. The method of 43, further comprising depositing an electrically insulating element on at least a portion of said second shell prior to step (ii).
- 15 45. The method of 43, further comprising depositing an electrically insulating element on at least a portion of said resistive element.
 - 46. The method of 43, further comprising depositing a thermal barrier element on at least a portion of said resistive element.
 - 47. The method of 43, wherein said depositing comprises thermal spraying.